

The TI500 series EVA encapsulant is a fast cure type produced by Terasol Energy using state-of-the-art manufacturing and advanced technology. These encapsulants are known for their proven reliability, ensuring extended lifespan of solar photovoltaic systems in field environments. These encapsulants exhibit excellent technical properties, including resistance against PID (Potential Induced Degradation) and snail trail defects.

Test Parameter	Standard	Unit	Result	
			EVA - T15F	EVA - T15B
Thickness	ASTM D6988	Micron	400 - 800	
Width	Scale	mm	≤ 1350	
Shrinkage	150 °C @ 5 min.	%	MD : ≤3 % ; TD: ≤ 1 %	
Tensile Strength	ASTM D882	Мра	≥ 10	
Elongation at break	ASTM D882	%	≥ 600	
Peel Strength	ASTM D903	N/cm	>70	
Shore Hardness	ASTM D2240	Shore A	70 – 80	
Optical Transmittance	IEC 62788-1-4	%	≥ 91	
UV Cut-off Wave Length	IEC 62788-1-4	ATIMM NA	TIONS	360
Yellowness Index	ASTM E313	-	<2	
Gel Content	ASTM D2765 / Beaker Method	%	≥ 75	
Volume Resistivity	ASTM D257	ohm.cm	≥1 x 10 ¹⁵	
Water Absorption	ISO 62	%	≤ 0.2	

Lamination Parameter			
Evacuation Time (Minutes)	5 to 6		
Lamination Time (Minutes)	9 to 12		
Temperature (°C)	140 to 145		

Storage and Packing Details		
Storage Condition	dition Store at temperature 25 to 30 degree & Humidity 50 to 60%	
Shelf Life	Recommended to use before 6 months from the date of manufacturing.	